



EMH1302 — P-Channel Silicon MOSFET

General-Purpose Switching Device Applications

Features

- Low ON-resistance.
- 4V drive.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V _{DSS}		-30	V
Gate-to-Source Voltage	V _{GSS}		±20	V
Drain Current (DC)	I _D		-5	A
Drain Current (Pulse)	I _{DP}	PW≤10μs, duty cycle≤1%	-20	A
Allowable Power Dissipation	P _D	Mounted on a ceramic board (1200mm ² ×0.8mm)	1.5	W
Channel Temperature	T _{ch}		150	°C
Storage Temperature	T _{stg}		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	I _D =-1mA, V _{GS} =0V	-30			V
Zero-Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V, V _{GS} =0V			-1	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} =±16V, V _{DS} =0V			±10	μA
Cutoff Voltage	V _{GS(off)}	V _{DS} =-10V, I _D =-1mA	-1.2		-2.6	V
Forward Transfer Admittance	y _{fs}	V _{DS} =-10V, I _D =-2.5A	3.0	5.1		S
Static Drain-to-Source On-State Resistance	R _{DS(on)1}	I _D =-2.5A, V _{GS} =-10V		39	51	mΩ
	R _{DS(on)2}	I _D =-1.5A, V _{GS} =-4.5V		65	92	mΩ
	R _{DS(on)3}	I _D =-1.5A, V _{GS} =-4V		74	115	mΩ
Input Capacitance	C _{iss}	V _{DS} =-10V, f=1MHz		850		pF
Output Capacitance	C _{oss}	V _{DS} =-10V, f=1MHz		160		pF
Reverse Transfer Capacitance	C _{rss}	V _{DS} =-10V, f=1MHz		135		pF
Turn-ON Delay Time	t _{d(on)}	See specified Test Circuit.		12		ns
Rise Time	t _r	See specified Test Circuit.		43		ns
Turn-OFF Delay Time	t _{d(off)}	See specified Test Circuit.		80		ns
Fall Time	t _f	See specified Test Circuit.		45		ns

Marking : JB

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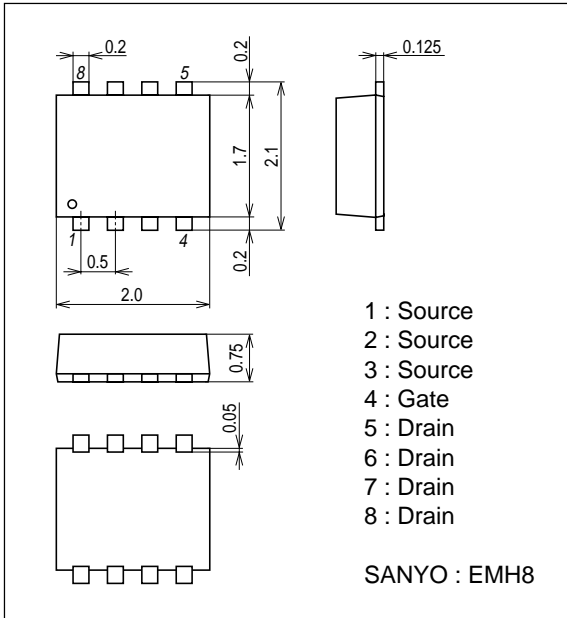
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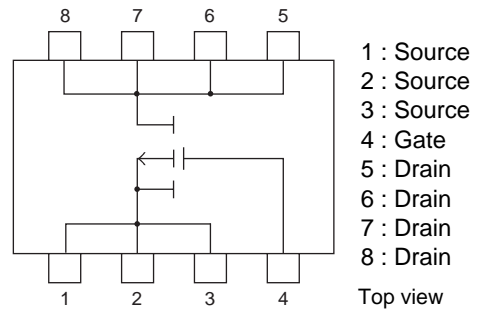
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Total Gate Charge	Qg	$V_{DS}=-10V, V_{GS}=-10V, I_D=-5A$		16.5		nC
Gate-to-Source Charge	Qgs	$V_{DS}=-10V, V_{GS}=-10V, I_D=-5A$		3.1		nC
Gate-to-Drain "Miller" Charge	Qgd	$V_{DS}=-10V, V_{GS}=-10V, I_D=-5A$		3.1		nC
Diode Forward Voltage	VSD	$I_S=-5A, V_{GS}=0V$		-0.85	-1.2	V

Package Dimensions

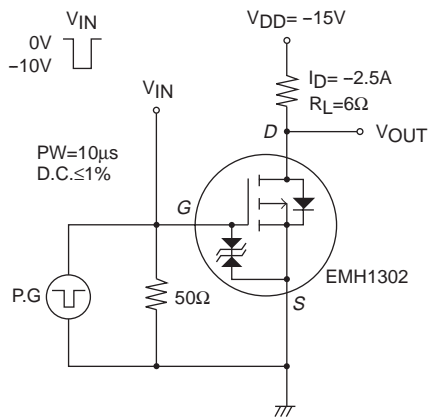
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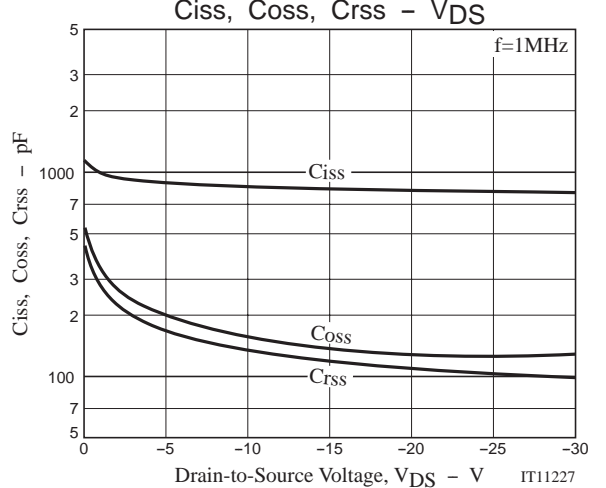
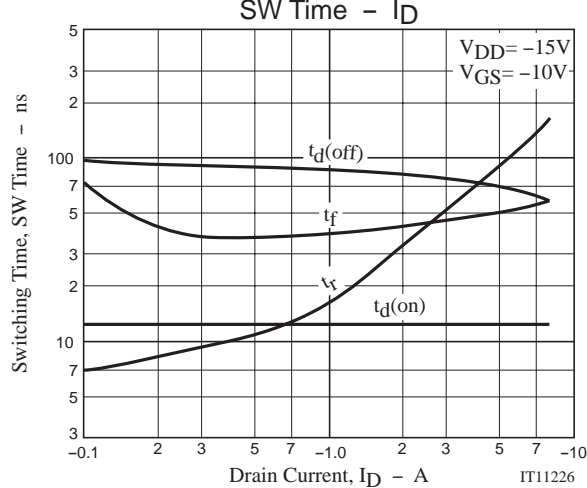
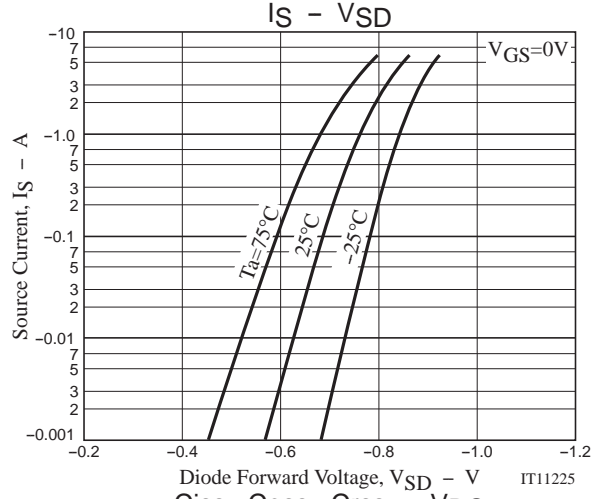
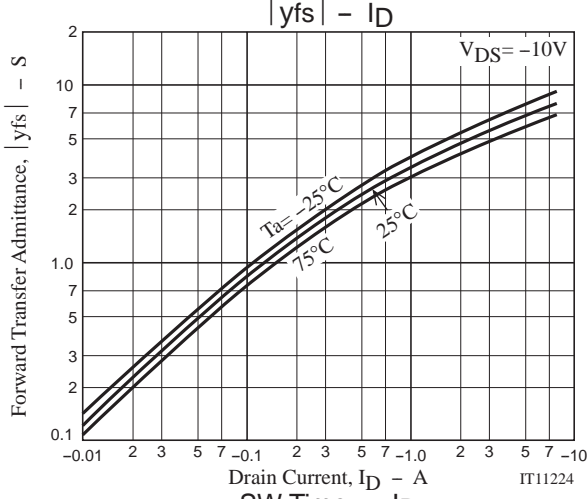
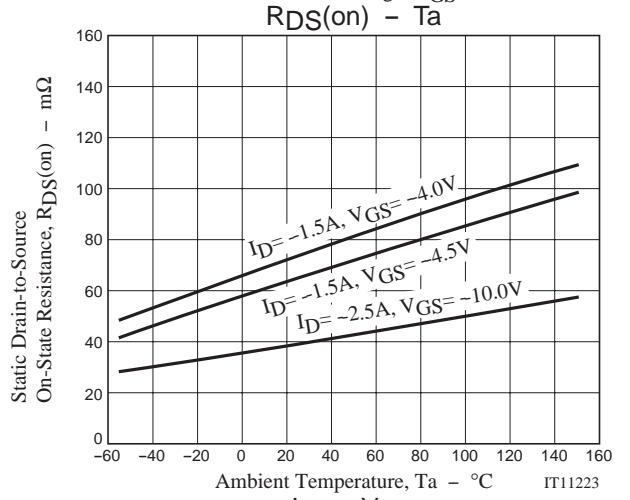
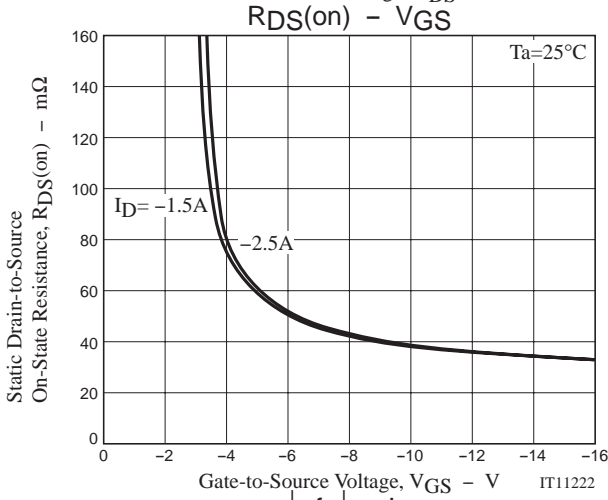
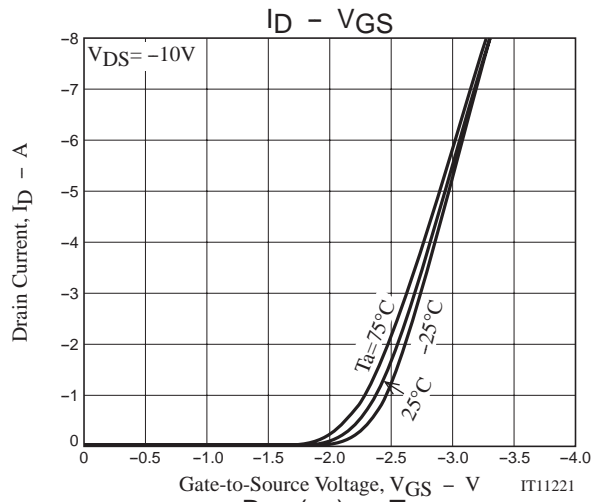
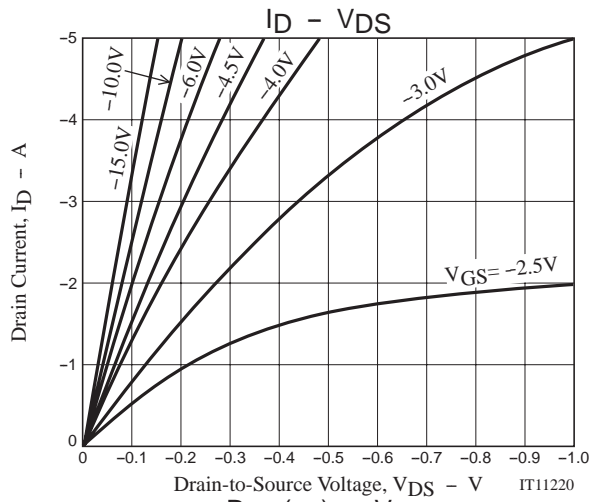


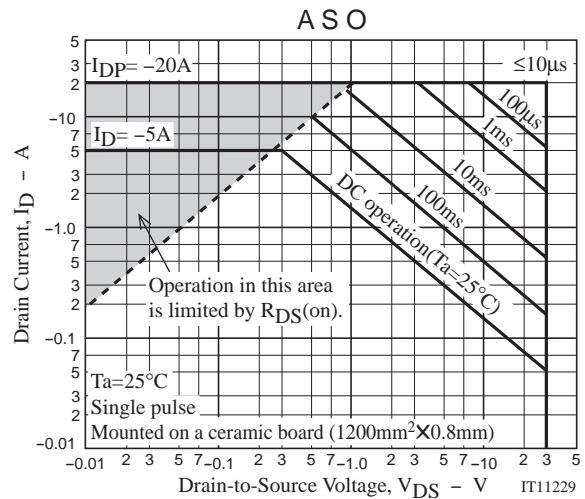
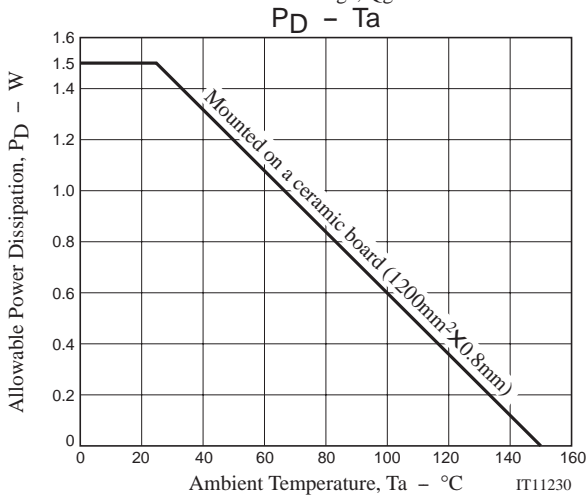
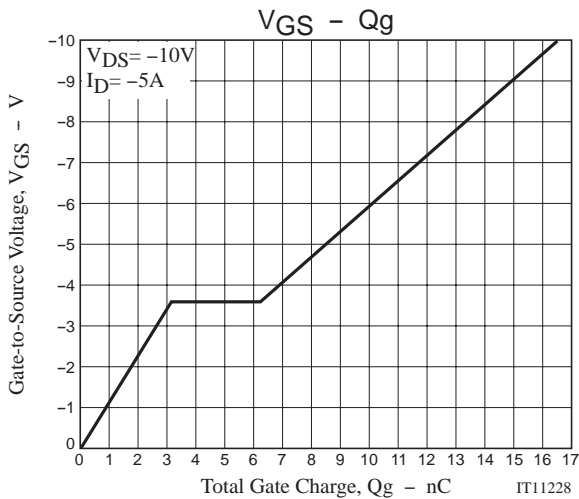
Electrical Connection



Switching Time Test Circuit







Note on usage : Since the EMH1302 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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